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	Part Number:	12015 0110		
		<u>43045-0418</u>		
	Status:	Active		
	Overview:	Micro-Fit 3.0 [™] Connectors		
	Description:	3.00mm Pitch Micro-Fit 3.0™	Header, Surface Mount, Dual Row, Vertical, with Solder	
		Tab, 4 Circuits, Tin (Sn) Platir	ng, Glow Wire Compatible	
				e Y
	Documents:			
	<u>3D Model</u>		Test Summary TS-43045-001 (PDF)	
	Drawing (PDF)		RoHS Certificate of Compliance (PDF)	
	Product Specification	<u>PS-43045 (PDF)</u>	Product Literature (PDF)	Series
ľ	-			image - Reference only
	Agency Certificat	tion		
	CSA		LR19980	EU RoHS China RoHS
	TUV		R72081037	ELV and RoHS
	UL		E29179	Compliant
	0L		223113	REACH SVHC
	General			Contains SVHC: No
	Product Family		PCB Headers	Low-Halogen Status
	Series		43045	Not Reviewed
	Application		Power, Wire-to-Board	
	Comments		"High Temperature Square Pin Solder Type <p><p>This</p></p>	Need more information on product
			Molex product is manufactured from material that has	environmental compliance?
			the following ratings, tested by independent agencies:	Email productcompliance@molex.com
			a) A Glow Wire Ignition Temperature (GWIT) of at	For a multiple part number RoHS Certificate of
			least 775 deg C per IEC 60695-2-13 b) A Glow	Compliance, click here
			Wire Flammability Index (GWFI) above 850 deg C	
			per IEC 60695-2-12.and hence complies with the	Please visit the <u>Contact Us</u> section for any
			requirements set out in the International Standard IEC	non-product compliance questions.
			60335-1 5th edition - household and similar electrical	
			appliances - safety, section 30 Resistance to heat	
			and fire. <p><p> The customers using this product</p></p>	
			must determine its suitability for use in their particular	Search Parts in this Series
			application through testing or other acceptable means	<u>43045</u> Series
			as described in end-product glow-wire flammability test	
			standard IEC 60695-2-11 and any applicable product	Mates With
			end-use standard(s). <p> If it is determined during</p>	43025
			the customer's evaluation of suitability, that higher	
			performance is required, please contact Molex for	
	O an is		possible product options."	
	Overview	Less NLs	Micro-Fit 3.0 [™] Connectors	
	Product Literature Ord	der No	987650-5984 Minus Fit 2.0TM	
	Product Name		Micro-Fit 3.0™	
	Physical			
	Breakaway		No	
	Circuits (Loaded)		4	
	Circuits (maximum)		4	
	Color - Resin		Black	
	Durability (mating cyc	les max)	30	
	Flammability	/	94V-0	
	Glow-Wire Compliant		Yes	
	Mated Height		17.27mm	
	Material - Metal		Brass	
	Material - Plating Mati	ing	Tin	
	Material - Plating Terr		Tin	
	Material - Resin		High Temperature Thermoplastic	
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Number of Rows2OrientationVerticalPCB LocatorYesPCB RetentionYesPCB Thickness - Recommended1.60mmPackaging TypeEmbossed Tape on ReelPitch - Mating Interface3.00mmPlating min - Mating0.889µmPlating min - Termination0.889µmPolarized to PCBYesShroudedFullyStackableNoSurface Mount Compatible (SMC)N/ATemperature Range - Operating-40°C to +105°CTermination Interface:Style Accurate MountElectricalSurface MountCurrent - Maximum per Contact5AVoltage - Maximum250VSolder Process Data30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Procest Temperature max. C260
PCB LocatorYesPCB RetentionYesPCB Thickness - Recommended1.60mmPackaging TypeEmbossed Tape on ReelPitch - Mating Interface3.00mmPlating min - Mating0.889µmPlating min - Termination0.889µmPolarized to PCBYesShroudedFullyStackableNoSurface Mount Compatible (SMC)N/ATemperature Range - Operating-40°C to +105°CTermination Interface: StyleSurface MountElectricalCurrent - Maximum per ContactCurrent - Maximum per Contact5AVoltage - Maximum250VSolder Process Data30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Accycles at Max. Process Temperature3Poress Temperature max. C260
PCB RetentionYesPCB Thickness - Recommended1.60mmPackaging TypeEmbossed Tape on ReelPitch - Mating Interface3.00mmPlating min - Mating0.889µmPlating min - Termination0.889µmPolarized to PCBYesShroudedFullyStackableNoSurface Mount Compatible (SMC)N/ATemperature Range - Operating-40°C to +105°CTermination Interface: StyleSurface MountElectrical5AVoltage - Maximum per Contact5AVoltage - Maximum250VSolder Process Data30Luration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Ax. Cycles at Max. Process Temperature3Corress Temperature max. C260
PCB Thickness - Recommended1.60mmPackaging TypeEmbossed Tape on ReelPicto - Mating Interface3.00mmPlating min - Mating0.889µmPlating min - Termination0.889µmPolarized to PCBYesShroudedFullyStackableNoSurface Mount Compatible (SMC)N/ATemperature Range - Operating-40°C to +105°CTermination Interface: StyleSurface MountElectrical5AVoltage - Maximum per Contact5AVoltage - Maximum250VSolder Process Data30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Ago260
Packaging TypeEmbossed Tape on ReelPitch - Mating Interface3.00mmPlating min - Mating0.889µmPlating min - Termination0.889µmPolarized to PCBYesShroudedFullyStackableNoSurface Mount Compatible (SMC)N/ATermperature Range - Operating-40°C to +105°CTermination Interface: StyleSurface MountElectricalCurrent - Maximum per ContactVoltage - Maximum250VSolder Process DataDuration at Max. Process Temperature (seconds)J030Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
Pitch - Mating Interface3.00mmPlating min - Mating0.889µmPlating min - Termination0.889µmPolarized to PCBYesShroudedFullyStackableNoSurface Mount Compatible (SMC)N/ATemperature Range - Operating-40°C to +105°CTermination Interface: StyleSurface MountElectricalCurrent - Maximum per Contact5AVoltage - Maximum250VSolder Process DataDuration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
Plating min - Mating0.889µmPlating min - Termination0.889µmPolarized to PCBYesShroudedFullyStackableNoSurface Mount Compatible (SMC)N/ATemperature Range - Operating-40°C to +105°CTermination Interface: StyleSurface MountElectricalCurrent - Maximum per Contact5AVoltage - Maximum250VSolder Process DataDuration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
Plating min - Termination0.889µmPolarized to PCBYesShroudedFullyStackableNoSurface Mount Compatible (SMC)N/ATemperature Range - Operating-40°C to +105°CTermination Interface: StyleSurface MountElectricalCurrent - Maximum per Contact5AVoltage - Maximum250VSolder Process DataDuration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
Polarized to PCBYesShroudedFullyStackableNoSurface Mount Compatible (SMC)N/ATemperature Range - Operating-40°C to +105°CTermination Interface: StyleSurface MountElectricalCurrent - Maximum per Contact5AVoltage - Maximum250VSolder Process DataDuration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
ShroudedFullyStackableNoSurface Mount Compatible (SMC)N/ATemperature Range - Operating-40°C to +105°CTermination Interface: StyleSurface MountElectricalCurrent - Maximum per Contact5AVoltage - Maximum250VSolder Process DataDuration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
StackableNoSurface Mount Compatible (SMC)N/ATemperature Range - Operating-40°C to +105°CTermination Interface: StyleSurface MountElectricalCurrent - Maximum per Contact5AVoltage - Maximum250VSolder Process DataDuration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
Surface Mount Compatible (SMC)N/ATemperature Range - Operating Termination Interface: Style-40°C to +105°CElectricalSurface MountCurrent - Maximum per Contact5AVoltage - Maximum250VSolder Process DataJonation at Max. Process Temperature (seconds)Duration at Max. Process Temperature30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
Temperature Range - Operating Termination Interface: Style-40°C to +105°C Surface MountElectricalSurface MountCurrent - Maximum per Contact Voltage - Maximum5A 250VSolder Process Data30 Reflow Capable (SMT only)Max. Cycles at Max. Process Temperature Process Temperature max. C30 260
Termination Interface: StyleSurface MountElectrical5ACurrent - Maximum per Contact5AVoltage - Maximum250VSolder Process Data30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
ElectricalCurrent - Maximum per Contact5AVoltage - Maximum250VSolder Process DataDuration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
Current - Maximum per Contact5AVoltage - Maximum250VSolder Process Data30Duration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
Current - Maximum per Contact5AVoltage - Maximum250VSolder Process Data30Duration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
Voltage - Maximum250VSolder Process Data30Duration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
Solder Process DataDuration at Max. Process Temperature (seconds)30Lead-free Process CapabilityReflow Capable (SMT only)Max. Cycles at Max. Process Temperature3Process Temperature max. C260
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Max. Cycles at Max. Process Temperature3Process Temperature max. C260
Process Temperature max. C 260
Material Info
UPC 800754370707
Reference - Drawing Numbers
Product Specification PS-43045, RPS-43045-003, RPS-43045-004
Sales Drawing SD-43045-007
Test Summary TS-43045-001

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